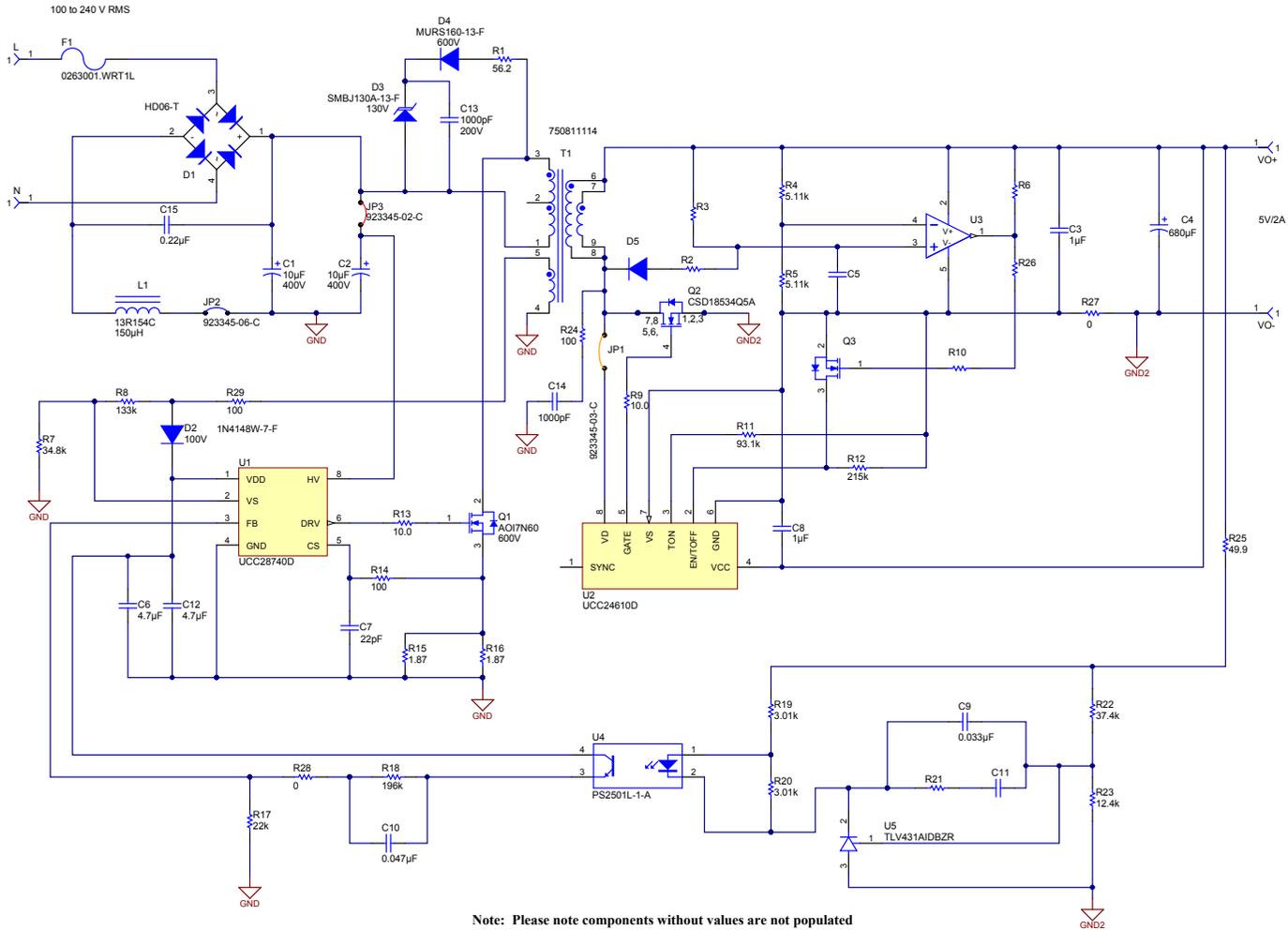


Revision History	
Revision	Notes



Note: Please note components without values are not populated

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Number: PMP8965	Rev: E2	Designed for Public Release	Mod. Date: 11/13/2014
SVN Rev: 639 (Locally Modified)	Assembly Variant: Variant name not interpreted	Project Title: UCC28740 12.5W USB reference design	Sheet: 1 of 1
Drawn By:	File: PMP8965_SchDoc	Size: B	http://www.ti.com
Engineer: Michael O'Loughlin	Contact: http://www.ti.com/support	© Texas Instruments 2014	



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